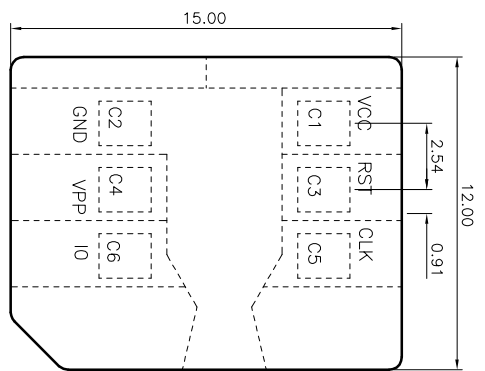
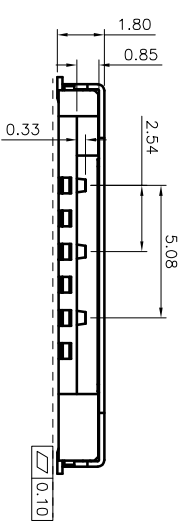
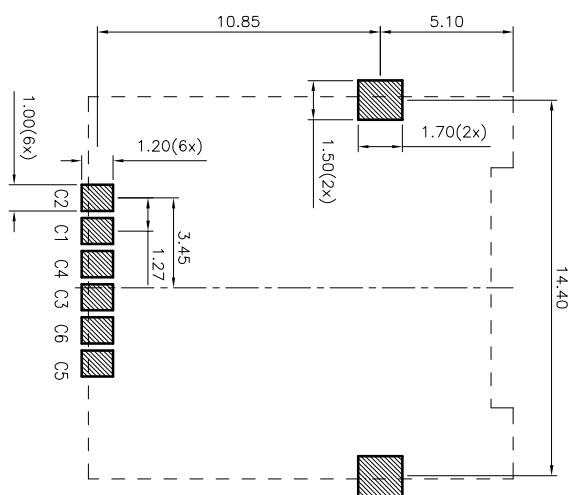
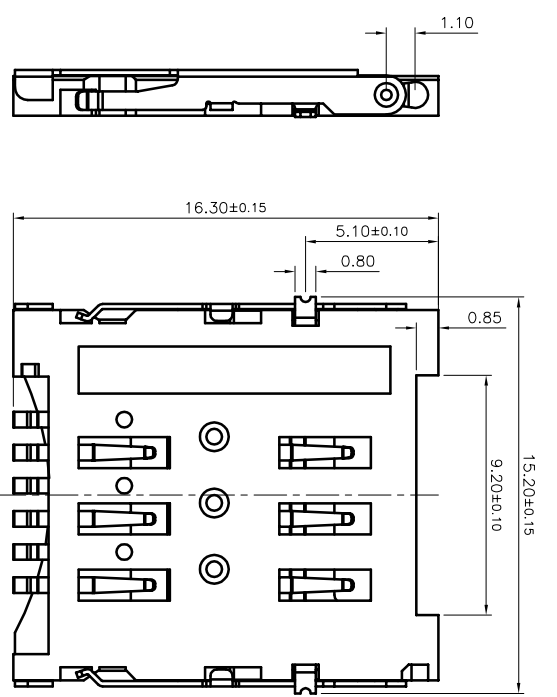
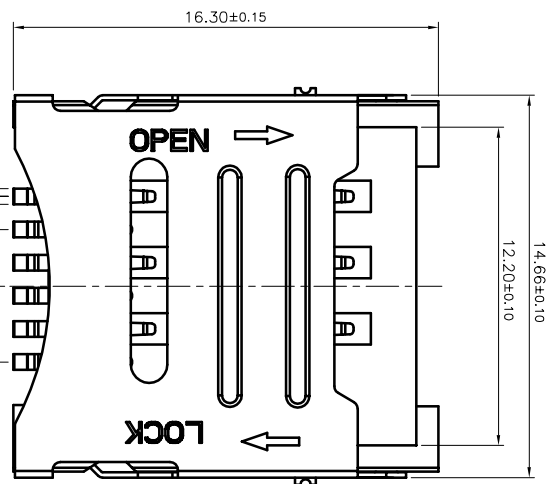


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
PROPOSE ONLY	ALLEN	2011.04.08	

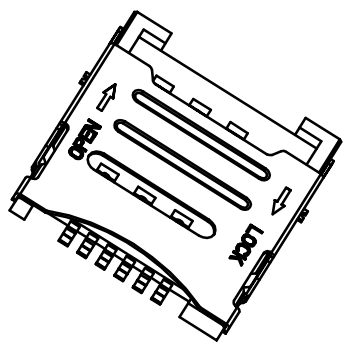


-NOTE-

- *Electrical Characteristics:
Contact Current Rating:0.5 Amperes.
Dielectric Withstanding Voltage:AC500V r.m.s.
Insulation Resistance:1000 MΩ Minimum.
Contact Resistance:40 mΩ Maximum.
- *Environmental:
Operating Temperature:-25°C+90°C.
- *Environmental:
Mating Cycles:3,000 Insertions.
- *Mechanical Characteristics:
Card Push Insertion/Out Force:0.7N±0.20kgf.
Contact Separation Force:0.20kgf Minimum.
- *Material:
Insulator:HI-Temp Plastic UL 94V-0 Rated.
Contact:Copper Alloy(t=0.15mm).
Shell:Stainless Steel(t=0.15mm).

3. PART No.: S O HG - 18 00 06 - 03 G

- SIM CARD
- 0=WITHOUT POST
- HG=HINGE Type.
- 18:HEIGHT 1.8mm
- G=gold flash
- 03=Product Order
- Pin NO. 6=6Pin
- 00=NORMAL TYPE.



RECOMMENDED P.C. BOARD LAYOUT(TOP VIEW)
GENERAL TOLERANCE:±0.05

NO.	DESCRIPTION	QTY	MATERIAL
3	TERMINAL	6	COOPER ALLOY
2	SHELL	1	STAINLESS STEEL
1	HOUSING	1	THERMOPLASTIC
			UL 94V-0
			材料
			材料

DECIMALS:	ANGLES:
X :±0.5	X :±2°
X.X :±0.20	X.X :±1°
X.XX :±0.10	

TITLE	1.8H HINGE MICRO SIM CARD CONN
DWN	ALLEN
CHKD	KEVIN
APVD	ERIC.W
	SCALE:1:1
	UNIT: mm
	SIZE: A3
	SHEET:1 OF 1
	REV: A1

深圳市顺宏康科技有限公司

1.8H HINGE MICRO SIM CARD CONN

CUSTOMER COPY